

Features

- Superior circuit protection
- Overcurrent and overvoltage protection
- Blocks surges up to rated limits
- High speed performance
- Small SMT package
- RoHS compliant*
- Agency recognition: ®

Applications

- Ethernet ports
- Protection modules and dongles
- Process control equipment
- Test and measurement equipment
- General electronics

TBU-DT Series - TBU® High Speed Protectors

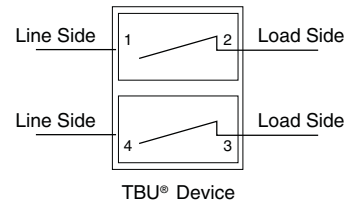
General Information

The TBU-DT Series of Bourns® TBU® (Transient Blocking Unit) products are very low capacitance dual unidirectional high speed surge protection components designed to protect against faults caused by short circuits, AC power cross, induction and lightning surges.

The TBU-DT series is a unidirectional TBU® device; the TBU® protector will trip in less than 1 μ s when the current reaches the maximum value in one direction only, that is when Pin 1 is positive in voltage with respect to Pin 2, and Pin 4 is positive with respect to Pin 3. No current limiting exists in the opposite polarity, and the TBU® device appears as resistive in nature. The reverse current should not exceed the maximum trip current level of the TBU® device. An external diode may be used to prevent reverse current in DC biased applications.

The TBU® protector blocks surges and provides an effective barrier behind which sensitive electronics will not be exposed to large voltages or currents during surge events. After the surge, the TBU® device resets when the voltage across the TBU® device falls to the V_{reset} level. The TBU® device will automatically reset on lines which have no DC bias or have DC bias below V_{reset} (such as unpowered signal lines).

The TBU® device is provided in a surface mount DFN package and meets industry standard requirements such as RoHS and Pb Free solder reflow profiles.



Agency Approval

Description	
UL	File Number: E315805

Absolute Maximum Ratings (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Part Number	Value	Unit
V_{imp}	Peak impulse voltage withstand with duration less than 10 ms	TBU-DT065-xxx-WH TBU-DT085-xxx-WH	650 850	V
V_{rms}	Continuous A.C. RMS voltage	TBU-DT065-xxx-WH TBU-DT085-xxx-WH	300 425	V
T_{op}	Operating temperature range		-40 to +85	$^\circ\text{C}$
T_{stg}	Storage temperature range		-65 to +150	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Part Number	Min.	Typ.	Max.	Unit	
$I_{trigger}$	Current required for the device to go from operating state to protected state	TBU-DTxxx-100-WH TBU-DTxxx-200-WH TBU-DTxxx-300-WH TBU-DTxxx-500-WH	100 200 300 500	150 300 450 750	200 400 600 1000	mA	
R_{device}	Series resistance of the TBU® device	$V_{imp} = 650\text{ V } I_{trigger}(\text{min.}) = 100\text{ mA}$ $V_{imp} = 650\text{ V } I_{trigger}(\text{min.}) = 200\text{ mA}$ $V_{imp} = 650\text{ V } I_{trigger}(\text{min.}) = 300\text{ mA}$ $V_{imp} = 650\text{ V } I_{trigger}(\text{min.}) = 500\text{ mA}$ $V_{imp} = 850\text{ V } I_{trigger}(\text{min.}) = 100\text{ mA}$ $V_{imp} = 850\text{ V } I_{trigger}(\text{min.}) = 200\text{ mA}$ $V_{imp} = 850\text{ V } I_{trigger}(\text{min.}) = 300\text{ mA}$ $V_{imp} = 850\text{ V } I_{trigger}(\text{min.}) = 500\text{ mA}$	TBU-DT065-100-WH TBU-DT065-200-WH TBU-DT065-300-WH TBU-DT065-500-WH TBU-DT085-100-WH TBU-DT085-200-WH TBU-DT085-300-WH TBU-DT085-500-WH		8.5 5.6 4.6 4.0 10.3 7.4 6.5 5.8	10.0 6.6 5.6 4.8 12.1 8.7 7.7 6.9	Ω
R_{match}	Package resistance matching of the TBU® device #1 - TBU® device #2		-0.5		+0.5	Ω	
t_{block}	Time for the device to go from normal operating state to protected state				1	μs	
I_Q	Current through the triggered TBU® device with 50 Vdc circuit voltage		0.25	0.50	1.00	mA	
V_{reset}	Voltage below which the triggered TBU® device will transition to normal operating state		12	16	20	V	
$R_{th(j-l)}$	Junction to package pads - FR4 using recommended pad layout			116		$^\circ\text{C/W}$	
$R_{th(j-s)}$	Junction to package pads - FR4 using heat sink on board (6 cm ²)			96		$^\circ\text{C/W}$	

*RoHS Directive 2002/95/EC Jan 27, 2003 including Annex.

Specifications are subject to change without notice.

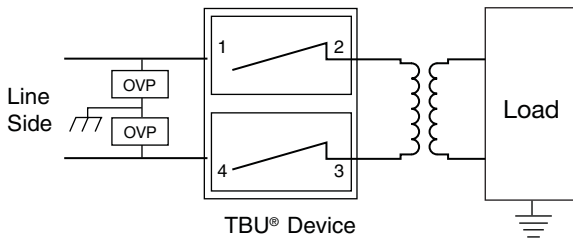
Customers should verify actual device performance in their specific applications.

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Reference Application

The TBU® device can be used to protect against excessive voltage surges in transformer coupled equipment, as shown in the figure below. The TBU® protector prevents any surges from causing damage. An overvoltage protection device, such as an MOV or GDT, may be used to provide additional overvoltage protection if the surge voltage is likely to be above the maximum rating of the TBU® device.



Basic TBU Operation

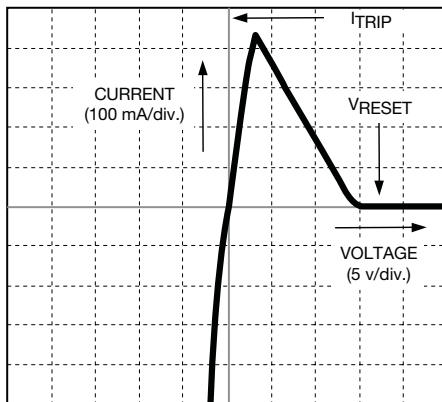
The TBU® device is a silicon-based, solid-state, resettable device which is placed in series with a signal path. The TBU® device operates in approximately 1 μ s - once line current exceeds the TBU® device's trigger current $I_{trigger}$. When operated, the TBU® device restricts line current to less than 1 mA typically. When operated, the TBU® device will block all system voltages and any other voltages including the surge up to rated limits.

After the surge, the TBU® device resets when the voltage across the TBU® device falls to the V_{reset} level. The TBU® device will automatically reset on lines which have no DC bias or have DC bias below V_{reset} (such as unpowered signal lines).

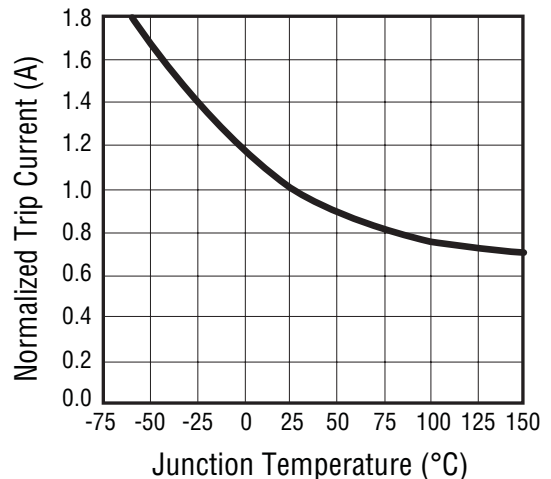
If the line has a normal DC bias above V_{reset} , the voltage across the TBU® device may not fall below V_{reset} after the surge. In such cases, special care needs to be taken to ensure that the TBU® device will reset, otherwise an automatic or manual power down will be required. Bourns application engineers can provide further assistance.

Performance Graphs

V-I Characteristic - TBU-DT085-300-WH (Pin 2-1 & Pin 3-4)



Typical Trigger Current vs. Temperature

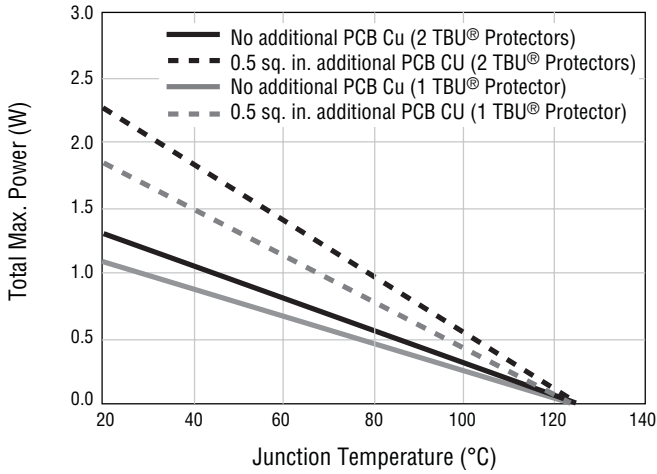


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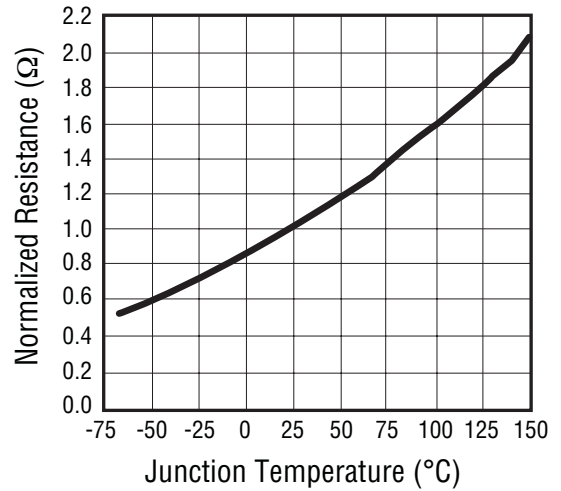
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Performance Graphs (Continued)

Power Derating Curve



Typical Resistance vs. Temperature



Reflow Profile

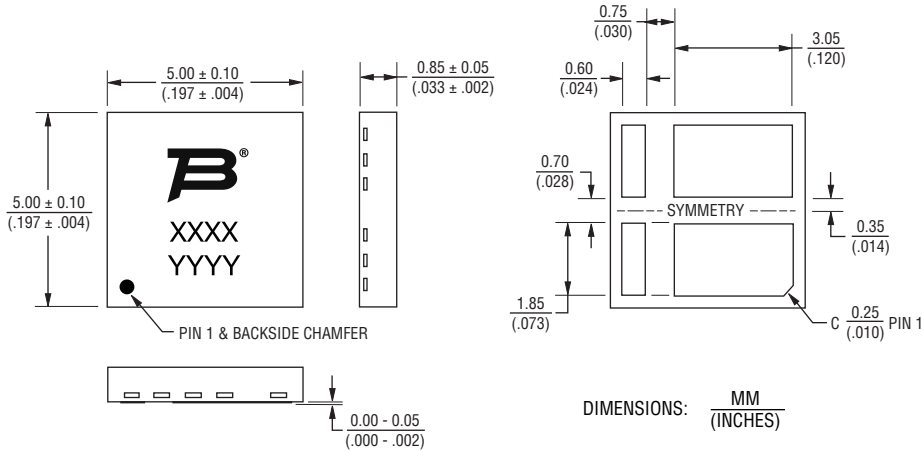
Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate (T _{smax} to T _p)	3 °C/sec. max.
Preheat	
- Temperature Min. (T _{smin})	150 °C
- Temperature Max. (T _{smax})	200 °C
- Time (t _{smin} to t _{smax})	60-180 sec.
Time maintained above:	
- Temperature (T _L)	217 °C
- Time (t _L)	60-150 sec.
Peak/Classification Temperature (T _p)	260 °C
Time within 5 °C of Actual Peak Temp. (t _p)	20-40 sec.
Ramp-Down Rate	6 °C/sec. max.
Time 25 °C to Peak Temperature	8 min. max.



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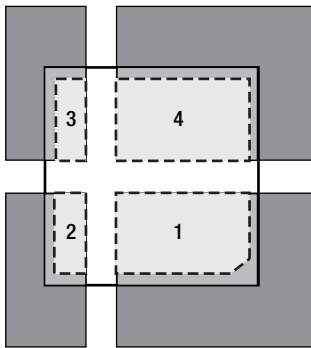
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Product Dimensions



Recommended Pad Layout

TBU® protectors have matte-tin termination finish. The suggested layout should use Non-Solder Mask Define (NSMD). The recommended stencil thickness is 0.10-0.12 mm (.004-.005 in.) with a stencil opening size 0.025 mm (.0010 in.) less than the device pad size. As when heat sinking any power device, it is recommended that wherever possible, extra PCB copper area is allowed. For minimum parasitic capacitance, do not allow any signal, ground or power signals beneath any of the pads of the device.

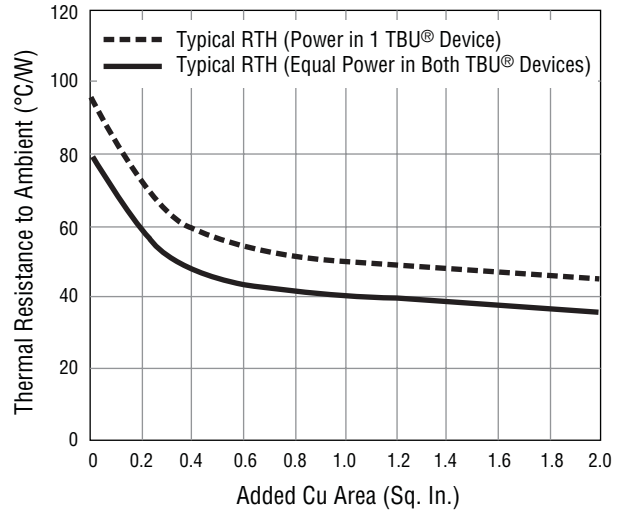


Pad Designation

Pad #	Pin Out
1	Line Side 1
2	Line Load 1
3	Line Load 2
4	Line Side 2

Dark grey areas show added PCB copper area for better thermal resistance.

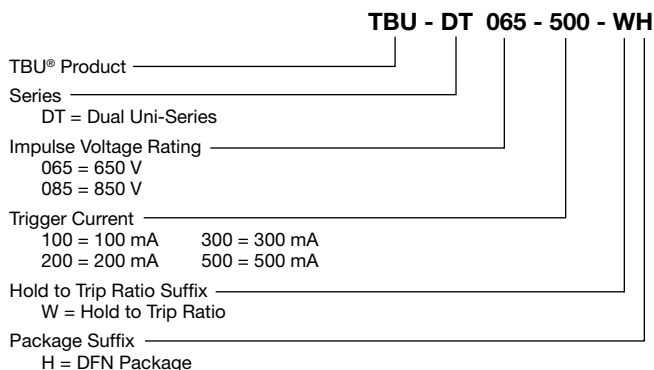
Thermal Resistance vs. Additional PCB Cu Area



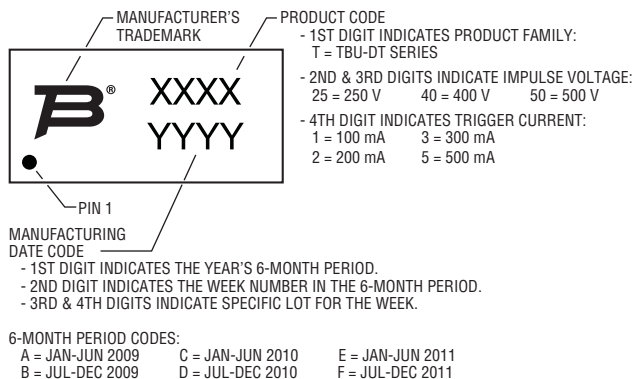
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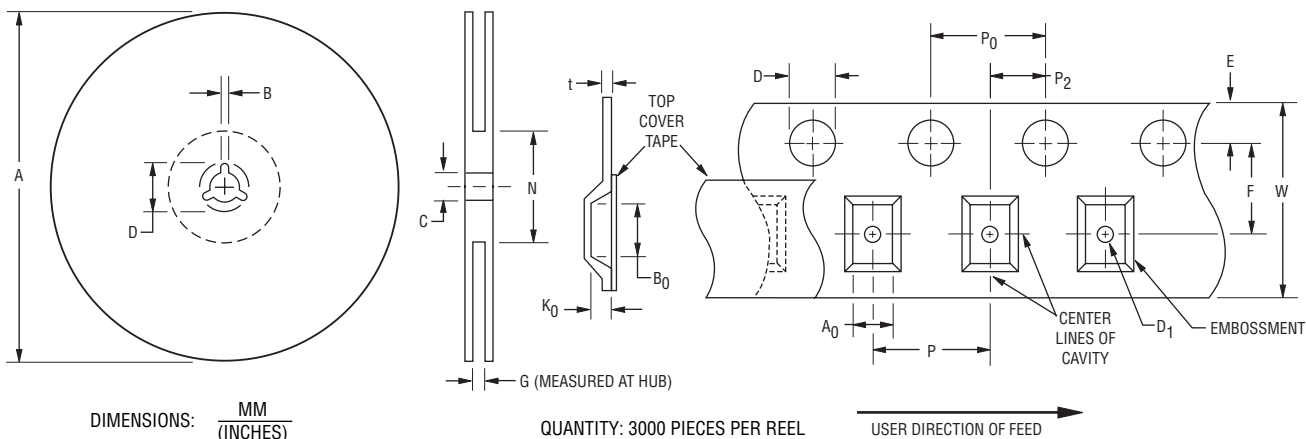
How to Order



Typical Part Marking



Packaging Specifications



A		B		C		D		G	N
Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Ref.	Ref.
326	330	1.5	2.5	12.8	13.5	20.2	-	16.5	102
(12.835)	(13.002)	(.059)	(.098)	(.504)	(.531)	(.795)		(.650)	(4.016)

A0		B0		D		D1		E		F	
Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.
5.4	5.6	5.4	5.6	1.5	1.6	1.5	-	1.65	1.85	7.4	7.6
(.212)	(.220)	(.212)	(.220)	(.059)	(.063)	(.059)		(.065)	(.073)	(.291)	(.299)
K0		P		P0		P2		t		W	
Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.
1.1	1.3	7.9	8.1	3.9	4.1	1.9	2.1	0.25	0.35	15.7	16.3
(.043)	(.051)	(.311)	(.319)	(.159)	(.161)	(.075)	(.083)	(.010)	(.014)	(.618)	(.642)

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Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

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Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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